

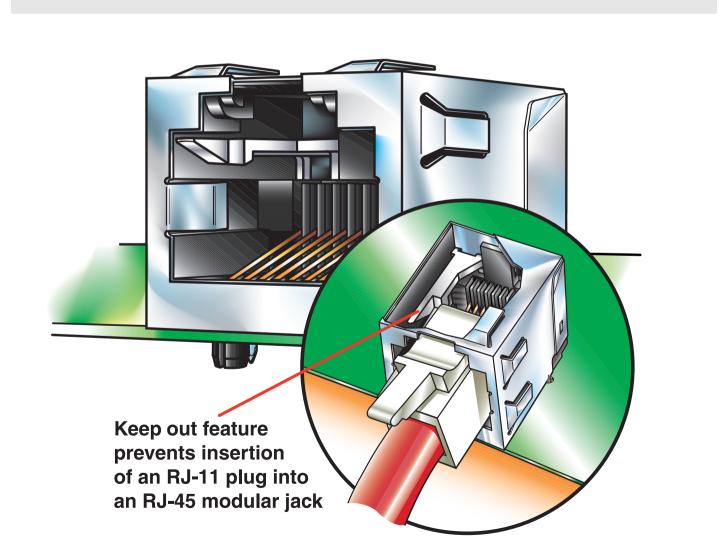
New RJ-45 Modular Jack with Keep Out Feature Eliminates Mis-mating to RJ-11 Plug

Eliminating the insertion and mis-mating of an RJ-11 (6 circuit) plug into an RJ-45 (8 circuit) modular jack is a concern for many telecommunication, networking, and computer manufacturers. For example, PC manufacturers have frequent calls from customers who do not realize they are inserting a typical RJ-11 phone line plug into an RJ-45 Ethernet modular jack port. This mis-mating not only causes the user frustration since the intended connection is not made, but the modular jack can be damaged by the insertion of the wrong size plug.

Molex has designed an RJ-45 modular jack with an RJ-11 plug keep out feature that prevents mis-mating. This unique design

incorporates an integrally molded lever inside the modular jack that blocks the insertion of an RJ-11 plug to fully mate with the modular jack. The lever does not interfere with an RJ-45 plug, however. When an RJ-45 plug is inserted into the RJ-45 modular jack, the keep out lever moves out of the way, allowing the plug to fully mate with the modular jack.

This design is incorporated into the Molex inverted modular jack that meets Category 5 for Fast Ethernet. The top latch feature on the modular jack provides easy access to the plug latch during unmating. The modular jack is offered in both unshielded and shielded configurations.



FEATURES AND SPECIFICATIONS

Features and Benefits

- Prevents mismating of RJ-11 plugs into RJ-45 iack
- Meets Category 5 for Fast Ethernet
- Plug latch on top
- Shield with enhanced panel grounding tabs
- 100% tested for hi-pot and continuity
- Shortened leads with bottom contacts

Reference Information

Product Specification: PS-43860-0003 Packaging: Unshielded—Tube Shielded—Tray UL File No.: E107635 CSA File No.: LR19980 Mates with: FCC 68 Plugs **Designed in: Inches**

Electrical

Voltage: 125V Current: 1.5A max. Contact Resistance: $10m\Omega$ max. Dielectric Withstanding Voltage: 1000V AC Insulation Resistance: 500 MQ min.

Mechanical

Durability: 500 cycles

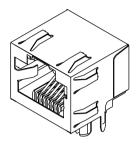
Physical

Housing: Black glass-filled, high-temperature nylon, UL 94V-0 Plating: Contact Area—1.27µm (50µ") min. Gold Solder Tail Area—1.27µm (50µ") Tin/Lead Underplating—Nickel Operating Temperature: -40 to +80°C

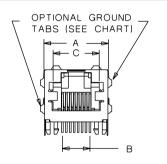
Modular Jack **molex**®

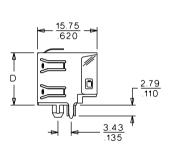
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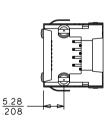
Right Angle RJ-45 Low Profile Inverted Shielded And Unshielded Versions With RJ-11 Keepout Feature

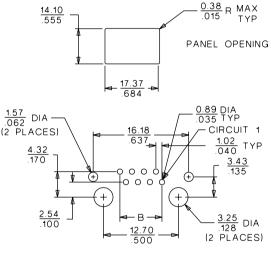


CATALOG DRAWING (FOR REFERENCE ONLY)









PCB LAYOUT : COMPONENT SIDE <u>1.57</u> RECOMMENDED PCB THICKNESS

ORDERING INFORMATION AND DIMENSIONS

Circuits	Loaded Contacts	Order Number			Dimension			
		Unshielded	Shielded					
			With All Panel Grounding Tabs	With Offset Panel Grounding Tabs	A	В	C	D
8	8	44620-0001			15.75 (.620)	7.11 (.280)	11.91 (.469)	13.21 (.520)
			44620-0002		16.38 (.645)	7.11 (.280)	11.91 (.469)	13.53 (.533)
				44620-0003	16.38 (.645)	7.11 (.280)	11.91 (.469)	13.53 (.533)

Note: Contact Molex for 30µ." select Gold plating or for alternative rear and center grounding tab option order numbers

Americas Headquarters Lisle, Illinois 60532 U.S.A. Tel:1-800-78MOLEX Fax:630-969-1352

Far East North Headquarters Yamato, Kanagawa, Japan Tel:81-462-65-2324 Fax:81-462-65-2366

Far East South Headquarters

Jurong, Singapore Tel:65-268-6868 Fax:65-265-6044 **European Headquarters** Munich, Germany

Tel:49-89-413092-0

Fax:49-89-401527

Corporate Headquarters 2222 Wellington Ct.

Lisle, IL 60532 U.S.A.

Tel:630-969-4550

Visit our Web site at http://www.molex.com